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- AC Types Feature 1.5-V to 5.5-V Operation and Balanced Noise Immunity at 30% of the Supply Voltage
- Contains Six Flip-Flops With Single-Rail Outputs
- Buffered Inputs
- Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption
- Balanced Propagation Delays
- ±24-mA Output Drive Current
  - Fanout to 15 F Devices
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015
- Applications Include:
  - Buffer/Storage Registers
  - Shift Registers

#### **E OR M PACKAGE** (TOP VIEW) 16 V<sub>CC</sub> CLR [ 1Q **[**] 2 15 6Q 1D 🛮 3 14 **∏** 6D 2D $\Pi$ 4 13 T 5D 12 5Q 2Q 🛮 5 3D **[**] 6 11**Π** 4D 3Q [] 7 10 4Q GND ¶8 9 CLK

#### description/ordering information

The CD74AC174 is a positive-edge-triggered D-type flip-flop with a direct clear (CLR) input and is designed for 1.5-V to 5.5-V V<sub>CC</sub> operation.

Information at the data (D) inputs that meets the setup time requirements is transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going edge of CLK. When CLK is at either the high or low level, the D input has no effect at the output.

#### ORDERING INFORMATION

TA	PACK	AGE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – E	Tube	CD74AC174E	CD74AC174E
–55°C to 125°C	SOIC M	Tube	CD74AC174M	AC174M
	SOIC – M	Tape and reel	CD74AC174M96	AC174W

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

## FUNCTION TABLE (each flip-flop)

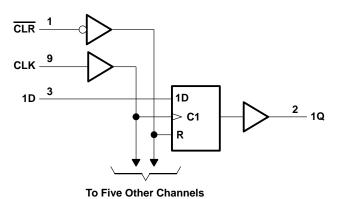
	INPUTS		OUTPUT
CLR	CLK	D	Q
L	Х	Х	L
Н	$\uparrow$	Н	Н
Н	$\uparrow$	L	L
Н	L	Χ	$Q_0$



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#### logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 6 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 V or V <sub>I</sub> > V <sub>CC</sub> ) (see Note 1)	
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 V or V <sub>O</sub> > V <sub>CC</sub> ) (see Note 1)	±50 mA
Continuous output current, I <sub>O</sub> (V <sub>O</sub> > 0 V or V <sub>O</sub> < V <sub>CC</sub> )	±50 mA
Continuous current through V <sub>CC</sub> or GND	±150 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): E package	67°C/W
M package	73°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 3)

			T <sub>A</sub> = 2	25°C	–55°C to 125°C		–40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
Vcc	Supply voltage		1.5	5.5	1.5	5.5	1.5	5.5	V
		V <sub>CC</sub> = 1.5 V	1.2		1.2		1.2		
VIН	High-level input voltage	V <sub>CC</sub> = 3 V	2.1		2.1		2.1		V
		V <sub>CC</sub> = 5.5 V	3.85		3.85		3.85		
		V <sub>CC</sub> = 1.5 V		0.3		0.3		0.3	
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 3 V		0.9		0.9		0.9	V
		V <sub>CC</sub> = 5.5 V		1.65		1.65		1.65	
٧ <sub>I</sub>	Input voltage		0	VCC	0	VCC	0	VCC	V
٧o	Output voltage		0	VCC	0	VCC	0	VCC	V
IOH	High-level output current	V <sub>CC</sub> = 4.5 V to 5.5 V		-24		-24		-24	mA
lOL	Low-level output current	V <sub>CC</sub> = 4.5 V to 5.5 V		24		24		24	mA
4+/4>/	Input transition rice or fall rate	V <sub>CC</sub> = 1.5 V to 3 V		50		50		50	ns/V
ΔυΔν	Δt/Δv Input transition rise or fall rate	V <sub>CC</sub> = 3.6 V to 5.5 V		20		20		20	115/V

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CON	DITIONS	Vcc	T <sub>A</sub> = 2	25°C	–55°0 125		–40°C to 85°C		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
			1.5 V	1.4		1.4		1.4		
		$I_{OH} = -50  \mu A$	3 V	2.9		2.9		2.9		
			4.5 V	4.4		4.4		4.4		
Voн	$V_{OH}$ $V_{I} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -4 \text{ mA}$	3 V	2.58		2.4		2.48		V
		$I_{OH} = -24 \text{ mA}$	4.5 V	3.94		3.7		3.8		
		$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V			3.85				
		$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V					3.85		
			1.5 V		0.1		0.1		0.1	
		$I_{OL} = 50 \mu\text{A}$	3 V		0.1		0.1		0.1	
			4.5 V		0.1		0.1		0.1	
VOL	$V_I = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 12 mA	3 V		0.36		0.5		0.44	V
		I <sub>OL</sub> = 24 mA	4.5 V		0.36		0.5		0.44	
		$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V				1.65			
		$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V						1.65	
lį	$V_I = V_{CC}$ or GND		5.5 V		±0.1		±1		±1	μΑ
Icc	$V_I = V_{CC}$ or GND,	IO = 0	5.5 V		8		160		80	μΑ
Ci					10		10		10	pF

<sup>†</sup> Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 1.5 V (unless otherwise noted)

				–55°C to 125°C		–40°C to 85°C	
			MIN	MAX	MIN	MAX	
fclock	Clock frequency			8		9	MHz
	W Pulse duration	CLR low	50		44		
t <sub>W</sub>		CLK high or low	65		57		ns
t <sub>su</sub>	Setup time before CLK↑	Data	2		2		ns
th	Hold time, data after CLK↑		38		33		ns
t <sub>rec</sub>	Recovery time, before CLK↑	CLR↑	1.5		1.5		ns



### CD74AC174 HEX D-TYPE FLIP-FLOP WITH CLEAR

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## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted)

				55°C to		UNIT		
			MIN	MAX	MIN	MAX		
fclock	Clock frequency			68		77	MHz	
	W Pulse duration		CLR low	5.6		4.9		
t <sub>W</sub>		CLK high or low	7.3		6.4		ns	
t <sub>su</sub>	Setup time before CLK↑	Data	2		2		ns	
th	Hold time, data after CLK↑		4.2	·	3.7	·	ns	
t <sub>rec</sub>	Recovery time, before CLK↑	CLR↑	1.5		1.5		ns	

## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted)

			–55° 125		–40°C to 85°C				UNIT
			MIN	MAX	MIN	MAX			
fclock	Clock frequency			95		108	MHz		
	Pulse duration	Dulas duration	CLR low	4		3.5		no	
t <sub>W</sub>		CLK high or low	5.2		4.6		ns		
t <sub>su</sub>	Setup time before CLK↑	Data	2		2		ns		
th	Hold time, data after CLK↑		3		2.6		ns		
t <sub>rec</sub>	Recovery time, before CLK↑	CLR↑	1.5		1.5		ns		

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 1.5 V, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)		–55°C to 125°C		O°C to 8 UNIT	5°C
	(1141 01)	(6611 61)	MIN	MAX	MIN	MAX	UNIT
f <sub>max</sub>			8		9		MHz
<sup>t</sup> PLH	CLK	Any O		169		154	20
t <sub>PHL</sub>	CER	Any Q		169		154	ns
<sup>t</sup> PLH	CLR	Any Q		181		165	ns
t <sub>PHL</sub>	CLR	Ally Q		181		165	115

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	–55° 125		–40°C to 85°C		UNIT
		(6611 61)	MIN	MAX	MIN	MAX	
f <sub>max</sub>			68		77		MHz
<sup>t</sup> PLH	CLK	Any Q	4.7	18.9	4.9	17.2	no
<sup>t</sup> PHL	CLN		Ally Q	4.7	18.9	4.9	17.2
<sup>t</sup> PLH	CLR	Any O	5.1	20.3	5.2	18.5	nc
<sup>t</sup> PHL	CLR	Any Q	5.1	20.3	5.2	18.5	ns



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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

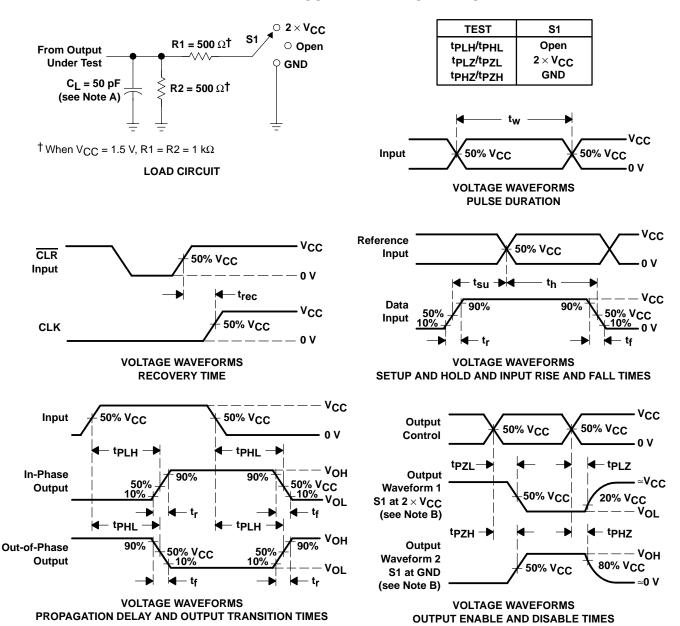
PARAMETER	FROM (INPUT)	TO (OUTPUT)	–55°( 125		–40°0 85°		UNIT
	(1141 01)	(6611 61)	MIN	MAX	MIN	MAX	
f <sub>max</sub>			95		108		MHz
<sup>t</sup> PLH	CLK	Any Q	3.4	13.5	3.5	12.3	ns
t <sub>PHL</sub>	CER	Ally Q	3.4	13.5	3.5	12.3	115
t <sub>PLH</sub>	CLR	Any Q	3.6	14.5	3.7	13.2	ns
<sup>t</sup> PHL	CLR	Ally Q	3.6	14.5	3.7	13.2	115

### operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	37	pF



#### PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \ \Omega$ ,  $t_f = 3 \ ns$ ,  $t_f = 3 \ ns$ . Phase relationships between waveforms are arbitrary.
  - D. For clock inputs, f<sub>max</sub> is measured with the input duty cycle at 50%.
  - E. The outputs are measured one at a time with one input transition per measurement.
  - F. tpLH and tpHL are the same as tpd.
  - G. tpzL and tpzH are the same as ten.
  - H. tpLz and tpHz are the same as tdis.
  - I. All parameters and waveforms are not applicable to all devices.

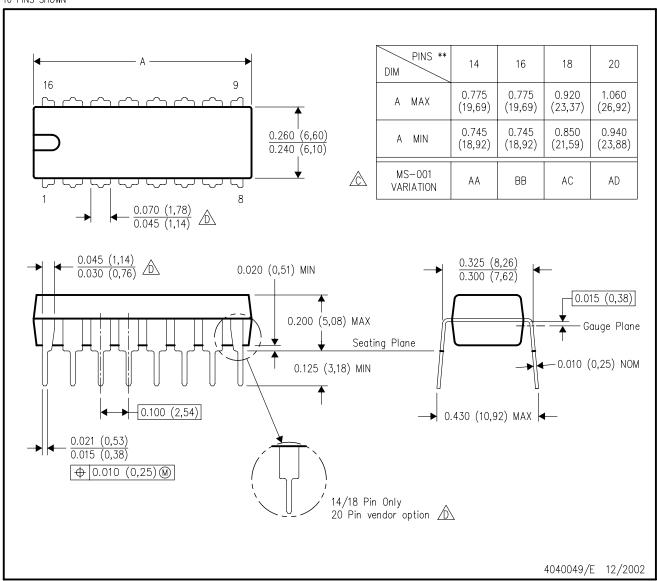
Figure 1. Load Circuit and Voltage Waveforms



### N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



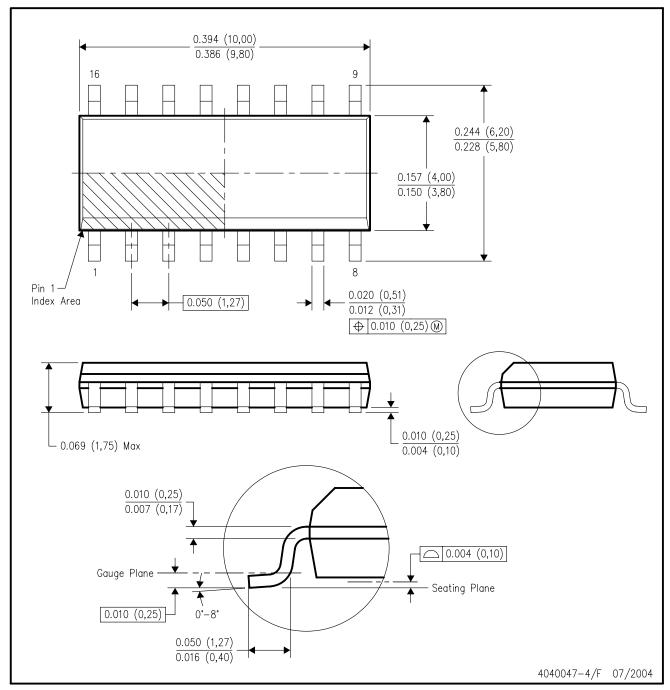
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



### D (R-PDSO-G16)

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



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